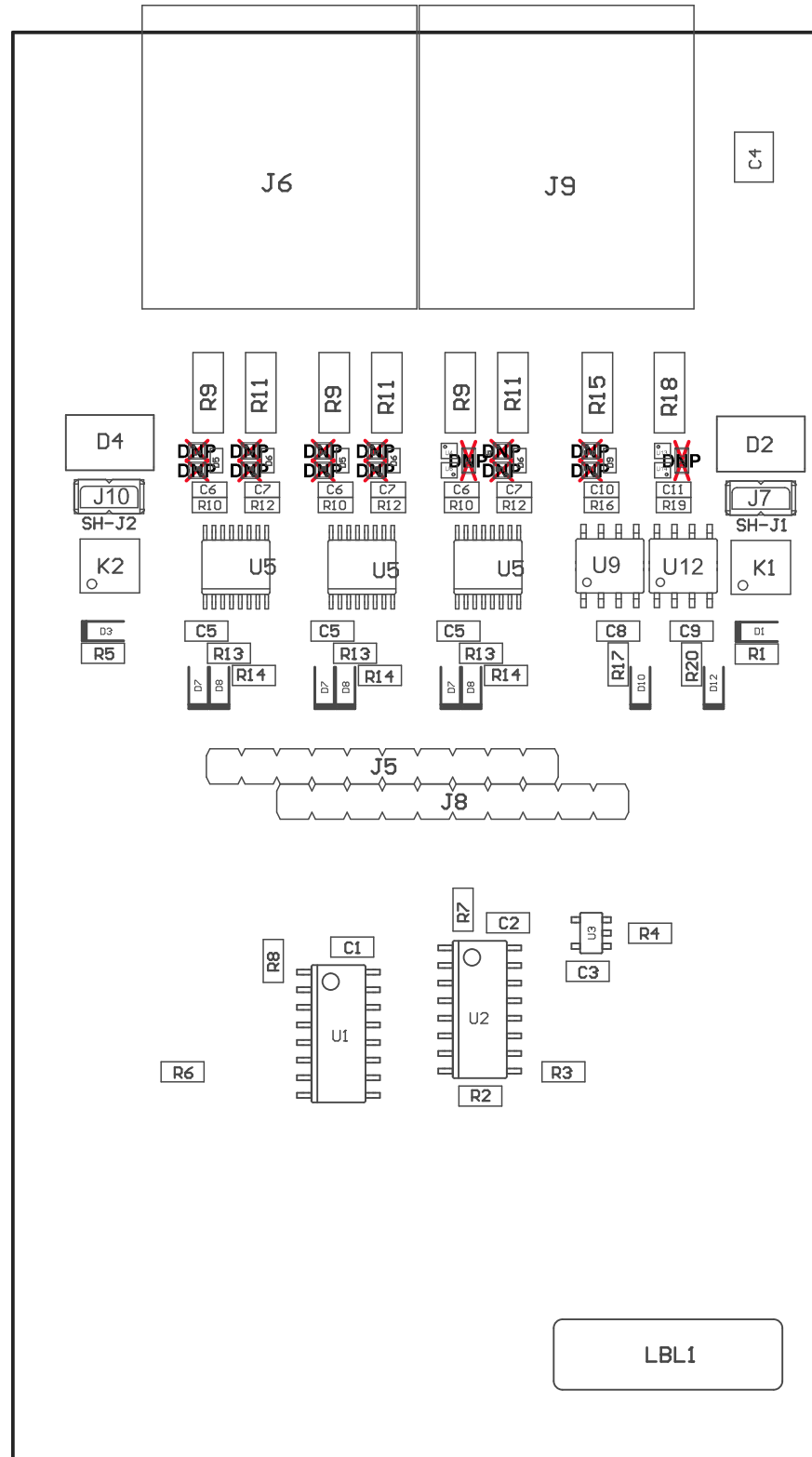
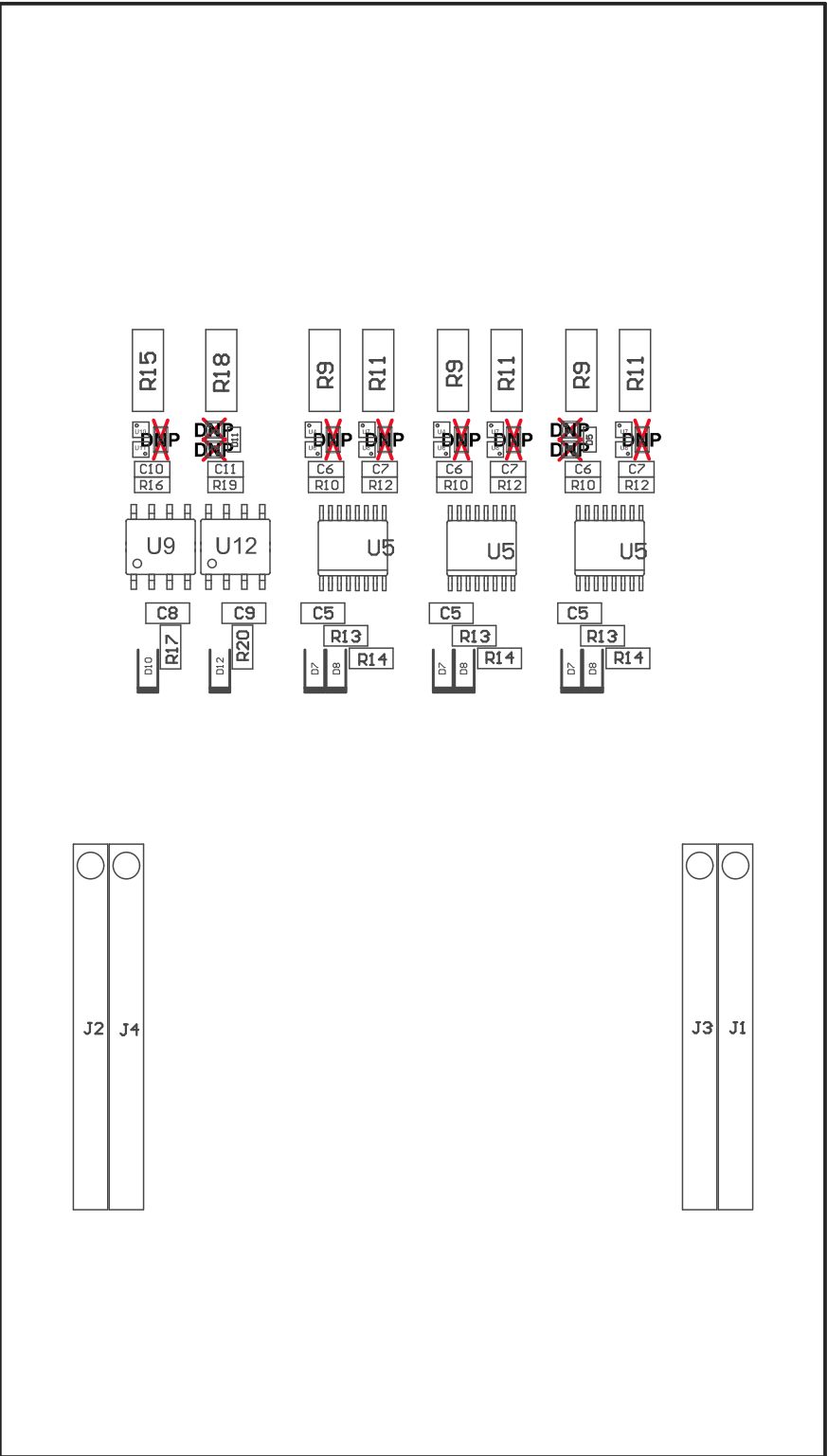


- ZZ1 ■ Install label in silkscreened box after final wash. Text shall be 8 pt font. Text shall be per the Label Table in the PDF schematic.
- ZZ2 ■ This Assembly Note will show in the PcbDoc and associated outputs
- ZZ3 ■ This Assembly Note will show in the PcbDoc and associated outputs
- ZZ4 ■ This Assembly Note will show in the PcbDoc and associated outputs



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
 ASSEMBLY VARIANT: CMB-Varistor-TVS

PCB VIEWED FROM TOP SIDE	BOARD #: TIDA-01508	REV: E1	SUN REV: Not In VersionControl
	TID #: TIDA-01508		
PLOT NAME = Top Assembly Drawing	GENERATED : 20.11.2017 13:37:05		TEXAS INSTRUMENTS



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
 ASSEMBLY VARIANT: CMB-Varistor-TVS

PCB VIEWED FROM BOTTOM SIDE	BOARD #: TIDA-01508	REV: E1	SUN REV: Not In VersionControl
	TID #: TIDA-01508		
PLOT NAME = Bottom Assembly Drawing	GENERATED : 20.11.2017 13:37:06		TEXAS INSTRUMENTS

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